

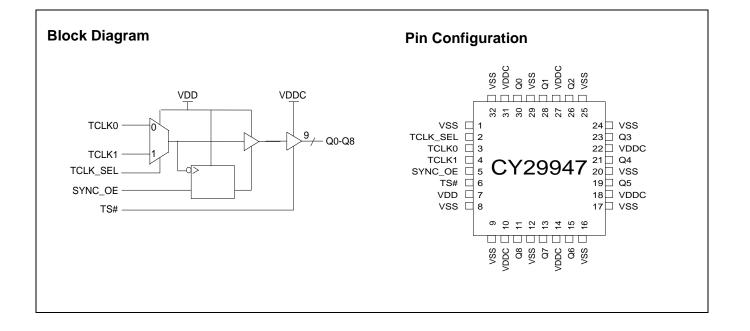
#### Features

- 2.5V or 3.3V Operation
- 200-MHz Clock Support
- LVCMOS/LVTTL Compatible Inputs
- 9 Clock Outputs: Drive up to 18 Clock Lines
- Synchronous Output Enable
- Output Three-state Control
- 250 ps max. Output to Output Skew
- Pin Compatible with MPC947
- Industrial Temp. Range: -40°C to +85°C
- 32-pin TQFP package

#### Description

The CY29947 is a low-voltage 200-MHz clock distribution buffer with the capability to select one of two LVCMOS/LVTTL compatible clock inputs. The two clock sources can be used to provide for a test clock as well as the primary system clock. All other control inputs are LVCMOS/LVTTL compatible. The 9 outputs are LVCMOS or LVTTL compatible and can drive two series terminated 50 $\Omega$  transmission lines. With this capability the CY29947 has an effective fan-out of 1:18. The outputs can also be three-stated via the three-state input TS#. Low output-to-output skews make the CY29947 an ideal clock distribution buffer for nested clock trees in the most demanding of synchronous systems.

The CY29947 also provides a synchronous output enable input for enabling or disabling the output clocks. Since this input is internally synchronized to the input clock, potential output glitching or runt pulse generation is eliminated.



eet • San Jose

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### **Pin Description**<sup>[1]</sup>

Pin	Name	PWR	I/O	Description
3	TCLK0		I, PU	Test Clock Input
4	TCLK1		I, PU	Test Clock Input
2	TCLK_SEL		I, PU	Test Clock Select Input. When LOW, TCLK0 is selected. When asserted HIGH, TCLK1 is selected.
11, 13, 15, 19, 21, 23, 26, 28, 30	Q(8:0)	VDDC	0	Clock Outputs
5	SYNC_OE		I, PU	Output Enable Input. When asserted HIGH, the outputs are enabled and when set LOW the outputs are disabled in a LOW state.
6	TS#		I, PU	Three-state Control Input. When asserted LOW, the output buffers are three-stated. When set HIGH, the output buffers are enabled.
10, 14, 18, 22, 27, 31	VDDC			3.3V or 2.5V Power Supply for Output Clock Buffers
7	VDD			3.3V or 2.5V Power Supply
1, 8, 9, 12, 16, 17, 20, 24, 25, 29, 32	VSS			Common Ground

Note:

1. PD = Internal Pull-Down, PU = Internal Pull-UP

#### **Output Enable/ Disable**

The CY29947 features a control input to enable or disable the outputs. This data is latched on the falling edge of the input clock. When SYNC\_OE is asserted LOW, the outputs are disabled in a LOW state. When SYNC\_OE is set HIGH, the outputs are enabled as shown in *Figure 1*.

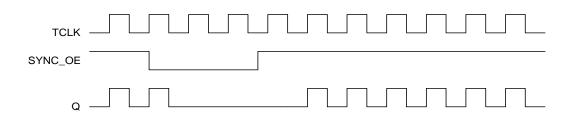


Figure 1. SYNC\_OE Timing Diagram



# **Maximum Ratings**

Maximum Input Voltage Relative to $V_{SS}$
Maximum Input Voltage Relative to $V_{DD}$ : $V_{DD}$ + 0.3V
Storage Temperature:65°C to + 150°C
Operating Temperature:40°C to +85°C
Maximum ESD protection2kV
Maximum Power Supply:
Maximum Input Current:

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field; however, precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. For proper operation,  $V_{\text{in}}$  and  $V_{\text{out}}$  should be constrained to the range:

$$V_{SS} < (V_{in} \text{ or } V_{out}) < V_{DD}$$

Unused inputs must always be tied to an appropriate logic voltage level (either  $V_{SS}$  or  $V_{DD}$ ).

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
V <sub>IL</sub>	Input Low Voltage		V <sub>SS</sub>		0.8	V
V <sub>IH</sub>	Input High Voltage		2.0		V <sub>DD</sub>	V
IIL	Input Low Current <sup>[2]</sup>				-100	μA
I <sub>IH</sub>	Input High Current <sup>[2]</sup>				10	μA
V <sub>OL</sub>	Output Low Voltage <sup>[3]</sup>	I <sub>OL</sub> = 20 mA			0.4	V
V <sub>OH</sub>	Output High Voltage <sup>[3]</sup>	I <sub>OH</sub> = -20 mA, V <sub>DD</sub> = 3.3V	2.5			V
		I <sub>OH</sub> = -20 mA, V <sub>DD</sub> = 2.5V	1.8			
I <sub>DDQ</sub>	Quiescent Supply Current			5	7	mA
I <sub>DD</sub>	Dynamic Supply Current	V <sub>DD</sub> = 3.3V, Outputs @ 100 MHz, CL = 30 pF		120		mA
		V <sub>DD</sub> = 3.3V, Outputs @ 160 MHz, CL = 30 pF		200		
		V <sub>DD</sub> = 2.5V, Outputs @ 100 MHz, CL = 30 pF		85		
		V <sub>DD</sub> = 2.5V, Outputs @ 160 MHz, CL = 30 pF		140		
C <sub>in</sub>	Input Capacitance			4		pF

#### **DC Parameters:** $V_{DD} = V_{DDC} = 3.3V \pm 10\%$ or 2.5V ±5%, $T_A = -40^{\circ}C$ to +85°C

Notes:

2. 3.

Inputs have pull-up/pull-down resistors that effect input current. Driving series or parallel terminated  $50\Omega$  (or  $50\Omega$  to V<sub>DD</sub>/2) transmission lines.



Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
Fmax Input Frequency <sup>[5]</sup>		V <sub>DD</sub> = 3.3V			200	MHz
		V <sub>DD</sub> = 2.5V			170	
Tpd	TCLK To Q Delay <sup>[5]</sup>	V <sub>DD</sub> = 3.3V	4.75		9.25	ns
		V <sub>DD</sub> = 2.5V	6.50		10.50	
FoutDC	Output Duty Cycle <sup>[5,6]</sup>	Measured at V <sub>DD</sub> /2	TCYCLE/2 - 800		TCYCLE/2 + 800	ns
tpZL, tpZH	Output Enable Time (all outputs)		2		10	ns
tpLZ, tpHZ	Output Disable Time (all outputs)		2		10	ns
Tskew	Output-to-Output Skew <sup>[5,8]</sup>			150	250	ps
Tskew(pp)	Part-to-Part Skew <sup>[9]</sup>				2.0	ns
Ts	Setup Time <sup>[5,7]</sup>	SYNC_OE to TCLK	0.0			ps
Th	Hold Time <sup>[5,7]</sup>	TCLK to SYNC_OE	1.0			ps
Tr/Tf	Output Clocks Rise/Fall Time <sup>[8]</sup>	0.8V to 2.0V, V <sub>DD</sub> = 3.3V	0.20		1.0	ns
		0.6V to 1.8V, V <sub>DD</sub> = 2.5V	0.20		1.3	

# **AC Parameters**<sup>[4]</sup>: $V_{DD} = V_{DDC} = 3.3V \pm 10\%$ or 2.5V $\pm 5\%$ , $T_A = -40^{\circ}C$ to $+85^{\circ}C$

Notes:

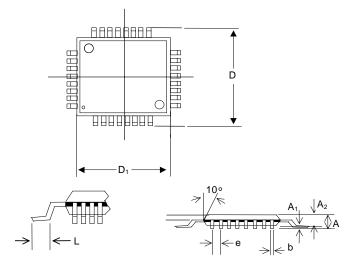
A. Parameters are guaranteed by design and characterization. Not 100% tested in production. All parameters specified with loaded outputs.
5. Outputs driving 50Ω transmission lines.
6. 50% input duty cycle.
7. Setup and hold times are relative to the falling edge of the input clock
8. Outputs loaded with 30 pF each.
9. Part-to-Part skew at a given temperature and voltage.



## **Ordering Information**

Part Number	Package Type	Production Flow
CY29947AI	32 Pin TQFP	Industrial, -40°C to +85°C

# **Package Drawing and Dimensions**



# 32 Pin TQFP Outline Dimensions

	Inches			I	Millimet	ers
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.
А	-	-	0.047	-	-	1.20
A1	0.002	-	0.006	0.05	-	0.15
A2	0.037	-	0.041	0.95	-	1.05
D	-	0.354	-	-	9.00	-
D1	-	0.276	-	-	7.00	-
b	0.012	-	0.018	0.30	-	0.45
е		0.031 BS	С		0.80BS	С
L	0.018	-	0.030	0.45	-	0.75

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REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change			
**	111098	02/07/02	BRK	New data sheet			